

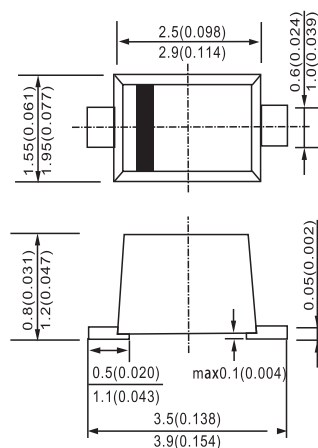
**FEATURES**

- For surface mounted applications
- Low-profile package
- Ideal for automated placement
- Low power loss, high efficiency
- High temperature soldering:  
260 °C/10 seconds at terminals
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC  
and WEEE 2002/96/EC

**Mechanical Data****Case:** JEDEC DO-219AB (SMF) Plastic case**Polarity:** Color band denotes cathode end**Weight:** approx. 15 mg**Packaging codes-options:**

G18 / 10 k per 13" reel (8 mm tape), 50 k/box

G08 / 3 k per 7" reel (8 mm tape), 30 k/box

**SOD-123FL**

Dimensions in millimeters

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS****Absolute Maximum Ratings** $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Maximum repetitive peak reverse voltage		SL02-M	$V_{RRM}$	20	V
		SL03-M	$V_{RRM}$	30	V
		SL04-M	$V_{RRM}$	40	V
Maximum RMS voltage		SL02-M	$V_{RMS}$	14	V
		SL03-M	$V_{RMS}$	21	V
		SL04-M	$V_{RMS}$	28	V

Parameter	Test condition	Part	Symbol	Value	Unit
Maximum DC blocking voltage		SL02-M	$V_{DC}$	20	V
		SL03-M	$V_{DC}$	30	V
		SL04-M	$V_{DC}$	40	V
Maximum average forward rectified current	$T_{ip} = 109\text{ }^{\circ}\text{C}$		$I_{F(AV)}$	1.1	A
Peak forward surge current 8.3 ms single half sine-wave			$I_{FSM}$	40	A

**Thermal Characteristics** $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air <sup>2)</sup>		$R_{thJA}$	180	K/W
Maximum operating junction temperature		$T_J$	125	$^{\circ}\text{C}$
Storage temperature range		$T_{STG}$	- 55 to 150	$^{\circ}\text{C}$

1) Mounted on epoxy substrate with 3 x 3 mm Cu pads ( $\geq 40\text{ }\mu\text{m}$  thick)

**RATINGS AND CHARACTERISTIC CURVES SL02-M THRU SL04-M**

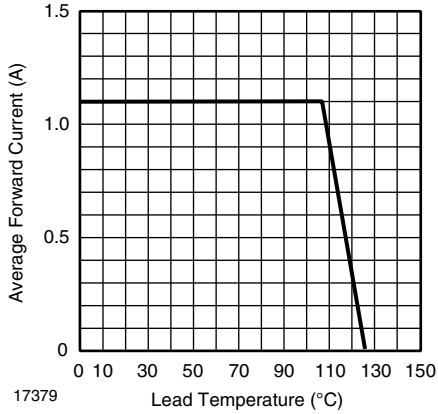


Figure 1. Forward Current Derating Curve

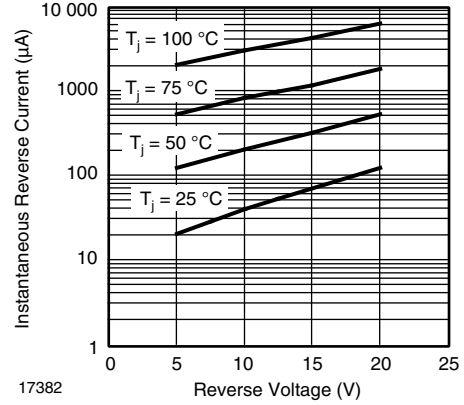


Figure 4. Typical Reverse Current Characteristics - SL02-M

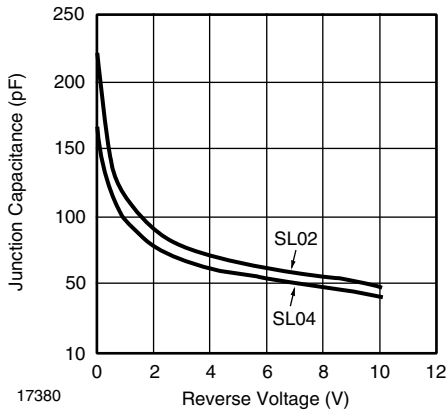


Figure 2. Typical Junction Capacitance

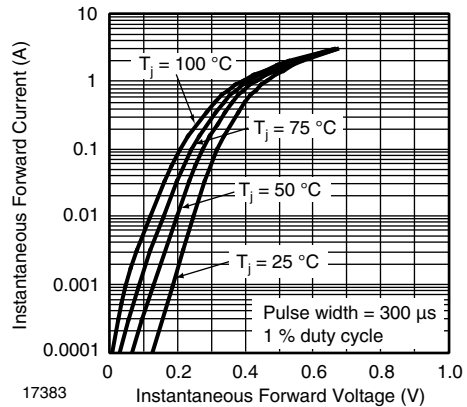


Figure 5. Typical Instantaneous Forward Characteristics - SL03-M

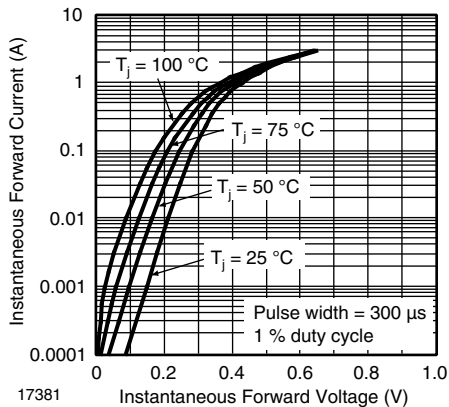


Figure 3. Typical Instantaneous Forward Characteristics - SL02-M

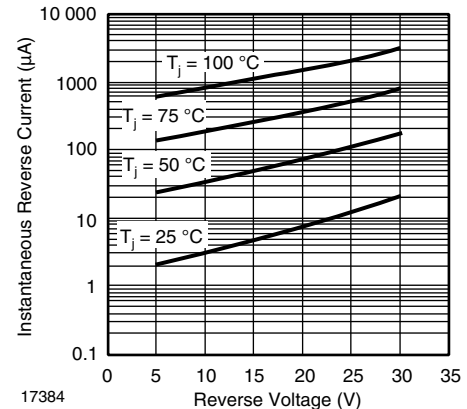


Figure 6. Typical Reverse Current Characteristics - SL03-M